SQJ140ER

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Automotive N-Channel 40 V (D-S) 175 °C MOSFET



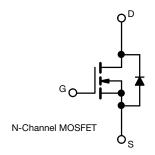
Top View

Bottom View

PRODUCT SUMMARY			
V _{DS} (V)	40		
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.00205		
I _D (A) ^d	170		
Configuration	Single		

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Q_{gd}/Q_{gs} ratio < 1 optimizes switching characteristics
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ORDERING INFORMATION		
Package	PowerPAK SO-10LR	
Lead (Pb)-free and halogen-free	SQJ140ER (for detailed order number please see <u>www.vishay.com/doc?79776</u>)	

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS} 40		V	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain current ^d	T _C = 25 °C	- I _D	170		
	T _C = 125 °C		98		
Continuous source current (diode conduction) ^d		I _S	123	А	
Pulsed drain current ^d		I _{DM}	683		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	38		
Single pulse avalanche energy		E _{AS}	72	mJ	
Maximum power dissipation	T _C = 25 °C	P _D	136	W	
	T _C = 125 °C		45		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) ^b		-	260		

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient ^c	PCB mount ^a	R _{thJA}	42	°C/W
Junction-to-case (drain)		R _{thJC}	1.1	0/10

Notes

a. When mounted on 1" square PCB (FR4 material)
b. See solder profile (<u>www.vishay.com/doc?73257</u>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

Using thermal characterization methods based on JESD51-14

d. Values based on RthJC and TC of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system

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1 For technical questions, contact: automostechsupport@vishay.com Document Number: 61608

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•		•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		40	-	-	v
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	2.4	2.5	3.5	v
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20$ V	-	-	± 100	nA
		V _{GS} = 0 V V _{DS} = 40 V		-	-	10	
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 175 °C	-	-	250	
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	30	-	-	А
		$V_{GS} = 10 V$	I _D = 15 A	-	0.00170	0.00205	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 15 A, T _J = 125 °C	-	-	0.0315	Ω
		V _{GS} = 10 V	I _D = 15 A, T _J = 175 °C	-	-	0.00378	
Forward transconductance b	g _{fs}	V _{DS}	$V_{DS} = 15 V, I_D = 75 A$		170	-	S
Dynamic ^b							
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	3341	4678	
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	932	1305	pF
Reverse transfer capacitance	C _{rss}			-	41	58	
Total gate charge ^c	Qg		V _{DS} = 20 V, I _D = 40 A	-	49	74	nC
Gate-source charge ^c	Q _{gs}	$V_{GS} = 10 V$		-	16	-	
Gate-drain charge ^c	Q _{gd}	1		-	12	-	
Gate resistance	Rg	f = 1 MHz		0.8	1.8	2.8	Ω
Turn-on delay time ^c	t _{d(on)}	$V_{DD} = 20 \text{ V}, \text{ R}_L = 0.5 \ \Omega$ $\text{I}_D \cong 40 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_g = 1 \ \Omega$		-	12	16	
Rise time ^c	t _r			-	6	9	ns
Turn-off delay time ^c	t _{d(off)}			-	25	38	
Fall time ^c	t _f			-	8	12	
Source-Drain Diode Ratings and Chara	acteristics ^b						
Pulsed current ^a	I _{SM}			-	-	422	А
Forward voltage	V _{SD}	I _F = 15 A, V _{GS} = 0 V		-	-	1.1	V
Body diode reverse recovery time	t _{rr}	I _F = 10 A, di/dt = 100 A/μs		-	45	90	ns
Body diode reverse recovery charge	Q _{rr}			46	92	nC	
Reverse recovery fall time	t _a			25	-		
Reverse recovery rise time	t _b			-	21	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-1.7	-	А

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

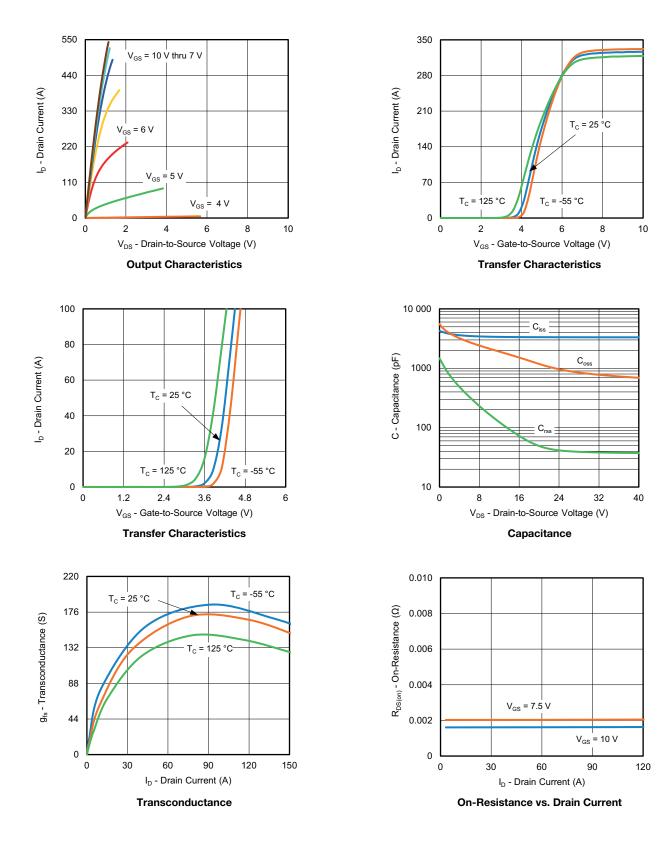
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



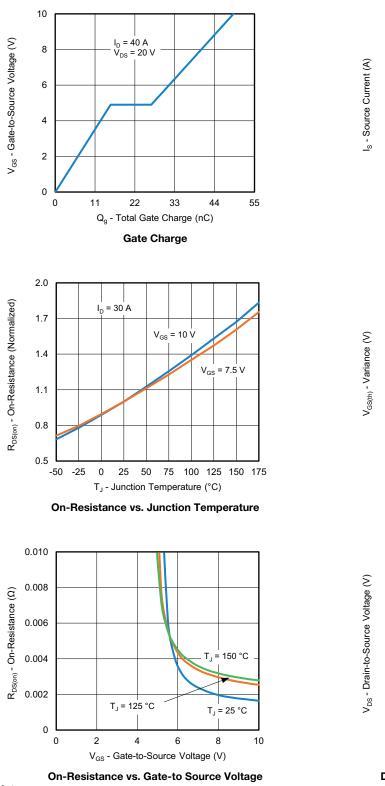
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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



¹⁰ T_J = 150 °C 1 0.1 T_J = 25 °C 0.01 0 0.2 0.4 0.6 0.8 1.0 V_{SD} - Source-to-Drain Voltage (V) Source Drain Diode Forward Voltage 0.6 0.3 0 -0.3 = 5 mA I_{Γ} -0.6 -0.9 I_D = 250 μA -1.2 -1.5 -50 -25 0 25 50 75 100 125 150 175 $T_{\rm J}$ - Junction Temperature (°C) **Threshold Voltage** 52 mΑ 51 50 49 48 47

100

45 45 -25 0 25 50 75 100 125 150 175 T_J - Junction Temperature (°C)

Drain Source Breakdown vs. Junction Temperature

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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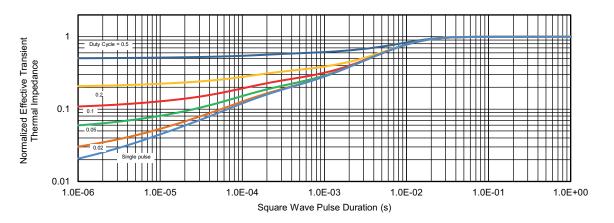
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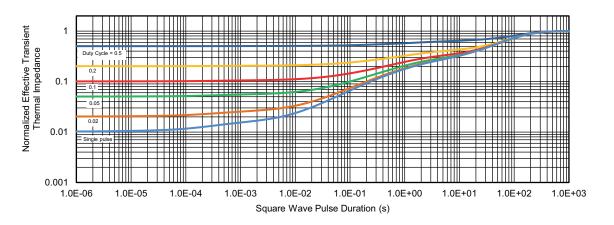
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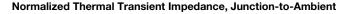
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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case





Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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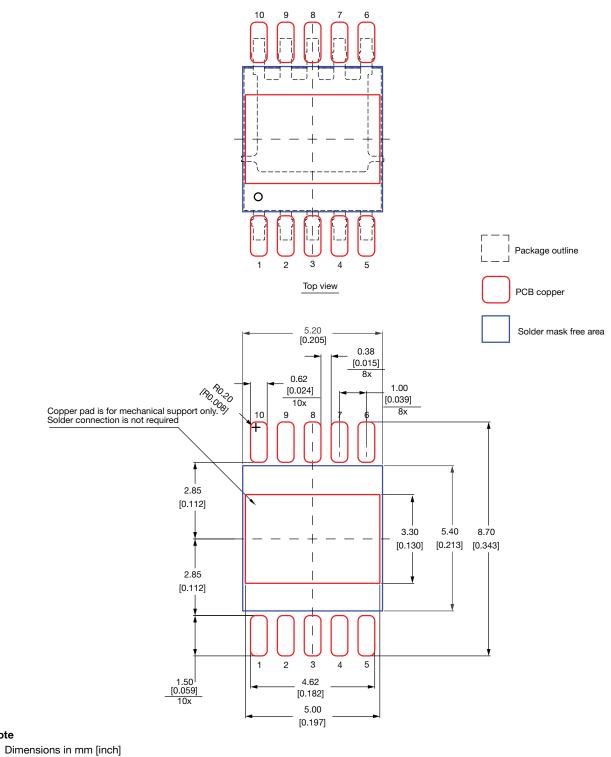
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PAD Pattern



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This land pattern is for reference

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Revision: 11-Dec-2023

Note

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